IEGT Module Silicon N-Channel IEGT

MG1200GXH1US61

1. Applications

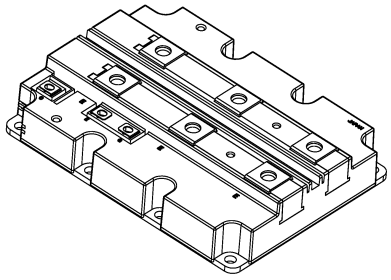
- High-Power Switching
- Motor Controllers

2. Features

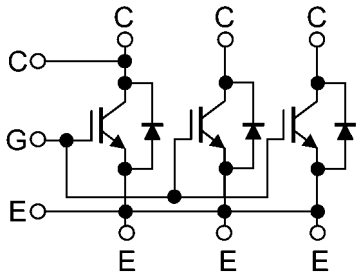
(1) Enhancement mode.

(2) Electrodes are isolated from case.

3. Packaging and Internal Circuit Pin Assignment (Note)



PMI193D



C: Collector (Cathode)
E: Emitter (Anode)
G: Gate

Note: Although main E-terminals are connected internally, they cannot lead rating current.
Please connect main E-terminals and C-terminals individually with conductive wire capable of leading rating current.

Start of commercial production
2016-06

4. Absolute Maximum Ratings (Note) (T_C = 25 °C Unless Otherwise Specified)

Characteristics	Symbol	Note	Test Condition	Rating	Unit
Collector-emitter voltage	V_{CES}			4500	V
Gate-emitter voltage	V_{GES}			±20	V
Collector current (DC)	I_C		T_c = 100 °C	1200	A
Collector current (pulsed)	I_{CP}	(Note 2)		2400	A
Diode forward current (DC)	I_F		T_c = 80 °C	1200	A
Diode forward current (pulsed)	I_{FP}	(Note 2)		2400	A
Non-repetitive peak forward surge current	I_{FSM}		10 ms (half-sine wave)	10	kA
Collector power dissipation	P_C	(Note 1)		15600	W
Junction temperature	T_j			-40 to 150	°C
Storage temperature	T_{stg}			-40 to 150	°C
Isolation voltage	V_{isol}		AC 1 min	6000	V
Mounting torque	TOR		Terminal: M4/M8	2/7	N · m
			Mounting: M6	4	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: In addition to the above remarks, refer to the application notes.

Note 2: Pulse width and repetition rate should be such that junction temperature (T_j) does not exceed maximum T_j rating.

5. Thermal Characteristics (Note)

Characteristics	Symbol	Note	Test Condition	Min	Typ.	Max	Unit
Thermal resistance (junction-to-case)	$R_{th(j-c)}$		Transistor part	—	—	8.0	K/kW
	$R_{th(j-c)}$		Diode part	—	—	16	
Thermal resistance (case-to-fin)	$R_{th(c-f)}$	(Note 1)	Per module	—	6.0	—	K/kW

Note: Customers must also refer to and comply with the latest versions of all relevant TOSHIBA information, including without limitation, this document, the specifications, the data sheets and application notes for Product and the precautions and conditions set forth in the "TOSHIBA Semiconductor Reliability Handbook" and the instructions for the application with which the Product will be used with or for.

Note 1: The heat radiation grease is recommended for use with semiconductor devices.
Apply a thin, even (100 to 200 μm) coating of grease.

6. Electrical Characteristics

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Gate-emitter leakage current	I_{GES}	V_{GE} = ±20 V, V_{CE} = 0 V, T_j = 25 °C	—	—	±20	nA
Collector-emitter cut-off current	I_{CES}	V_{CE} = 4500 V, V_{GE} = 0 V, T_j = 150 °C	—	—	100	mA
Gate-emitter cut-off voltage	$V_{GE(off)}$	I_C = 1.2 A, V_{CE} = 5 V, T_j = 150 °C	4.7	5.1	5.5	V
Collector-emitter saturation voltage	$V_{CE(sat)}$	I_C = 1200 A, V_{GE} = 15 V, T_j = 25 °C	—	2.5	—	V
		I_C = 1200 A, V_{GE} = 15 V, T_j = 150 °C	—	3.2	4.0	V
Input capacitance	C_{ies}	V_{CE} = 10 V, V_{GE} = 0 V, f = 100 kHz, T_j = 25 °C	—	210	—	nF
Switching time (turn-on delay time)	$t_{d(on)}$	V_{CC} = 2800 V, I_C = 1200 A, V_{GE} = ±15 V, $R_{G(on)}$ = 3.0 Ω, $R_{G(off)}$ = 10 Ω, T_j = 150 °C (Inductive load, L_s ≈ 200 nH) See Fig.6.1 and Fig.6.2	—	0.45	—	μs
Switching time (rise time)	t_r		—	0.22	—	μs
Switching time (turn-on time)	t_{on}		—	0.67	—	μs
Switching time (turn-off delay time)	$t_{d(off)}$		—	6.1	—	μs
Switching time (fall time)	t_f		—	2.1	—	μs
Switching time (turn-off time)	t_{off}		—	8.2	—	μs
Forward voltage	V_F	I_F = 1200 A, V_{GE} = 0 V, T_j = 25 °C	—	2.6	—	V
		I_F = 1200 A, V_{GE} = 0 V, T_j = 150 °C	—	3.0	3.6	V
Reverse recovery charge	Q_{rr}	V_{CC} = 2800 V, I_F = 1200 A, V_{GE} = -15 V, T_j = 150 °C Drive side: V_{GE} = ±15 V, $R_{G(on)}$ = 3.0 Ω (Inductive load, L_s ≈ 200 nH) See Fig.6.1 and Fig.6.3	—	1700	—	μC
Peak reverse recovery current	I_{rr}		—	1600	—	A
Reverse recovery time	t_{rr}		—	1.0	—	μs
Turn-on switching loss	E_{on}	V_{CC} = 2800 V, I_C = 1200 A, V_{GE} = ±15 V, $R_{G(on)}$ = 3.0 Ω, $R_{G(off)}$ = 10 Ω, T_j = 150 °C (Inductive load, L_s ≈ 200 nH) See Fig.6.1 and Fig.6.2	—	5.7	—	J
Turn-off switching loss	E_{off}		—	5.7	—	J
Reverse recovery loss	E_{rr}	V_{CC} = 2800 V, I_F = 1200 A, V_{GE} = -15 V, T_j = 150 °C Drive side: V_{GE} = ±15 V, $R_{G(on)}$ = 3.0 Ω (Inductive load, L_s ≈ 200 nH) See Fig.6.1 and Fig.6.3	—	3.0	—	J
Short-circuit pulse width	t_{psc}	V_{CC} = 3200 V, V_{GE} = ±15 V, $R_{G(on)}$ = 3.0 Ω, $R_{G(off)}$ = 10 Ω, T_j = 150 °C	—	—	6	μs

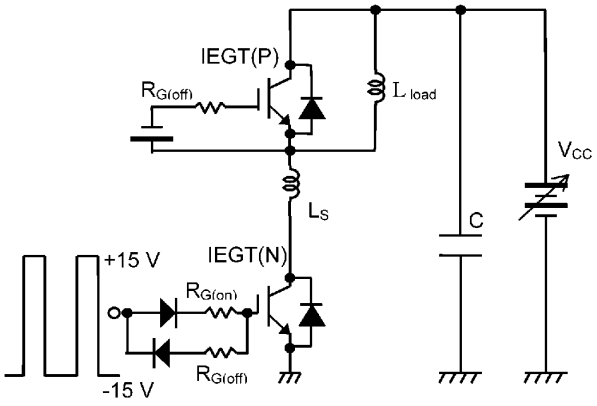
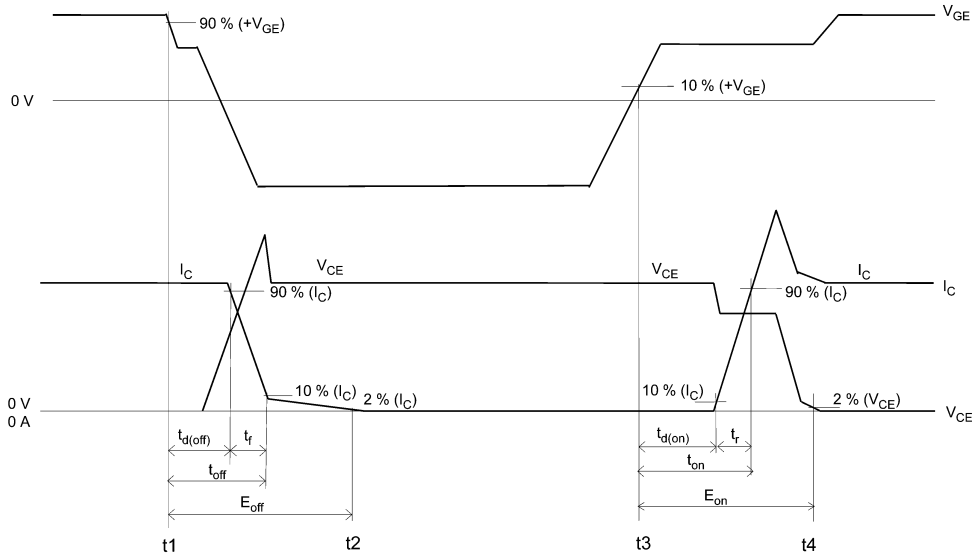
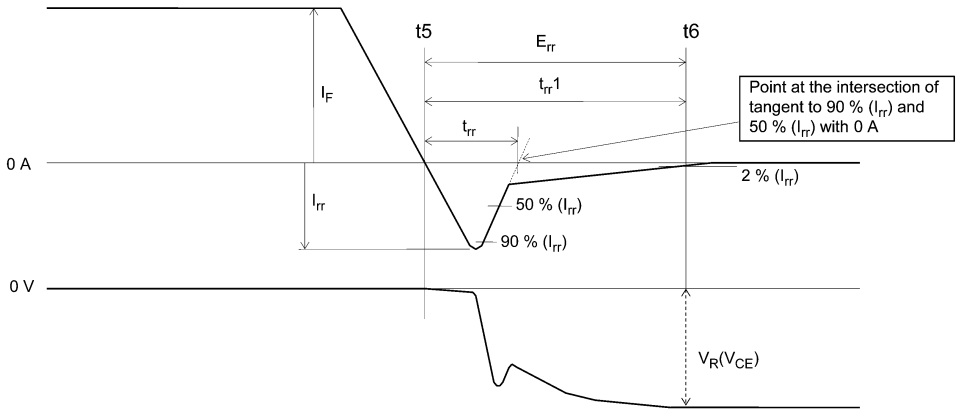


Fig. 6.1 Inductive Load Switching Test Circuit



$$E_{off} = \int_{t1}^{t2} I_C \times V_{CE}\, dt \qquad E_{on} = \int_{t3}^{t4} I_C \times V_{CE}\, dt$$

Fig. 6.2 Timing Chart (Transistor part)



$$E_{rr} = \int_{t5}^{t6} I_F \times V_R\, dt$$

Fig. 6.3 Timing Chart (Diode part)

7. Characteristics Curves (Note)

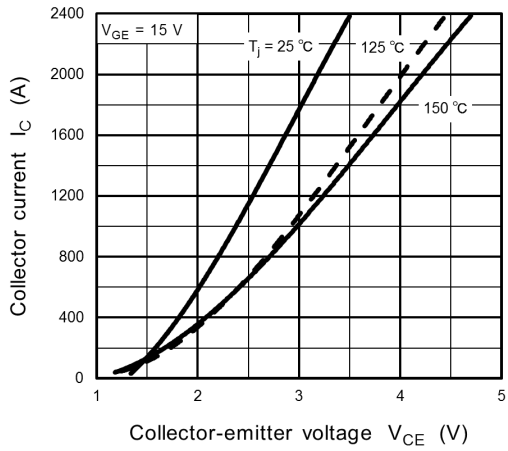


Fig. 7.1 I_C - V_{CE}

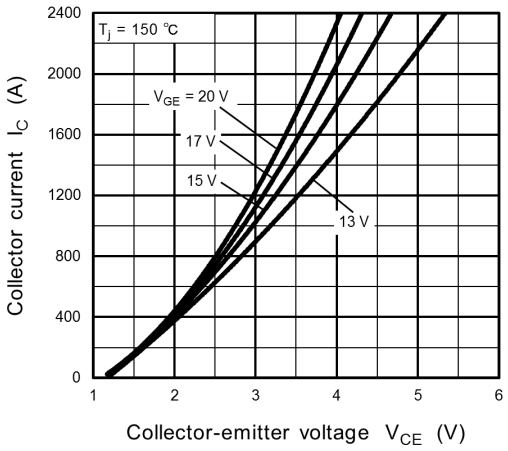


Fig. 7.2 I_C - V_{CE}

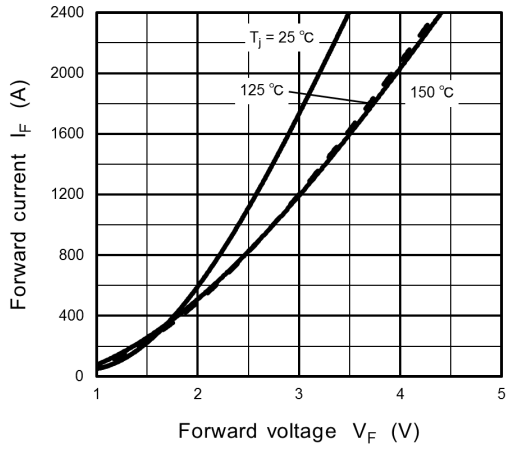


Fig. 7.3 I_F - V_F

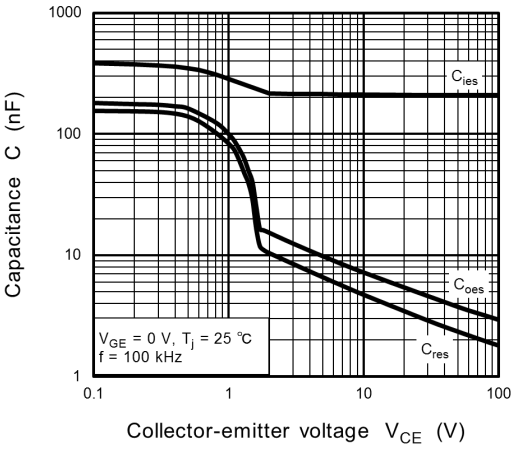


Fig. 7.4 C_{ies},C_{oes},C_{res} - V_{CE}

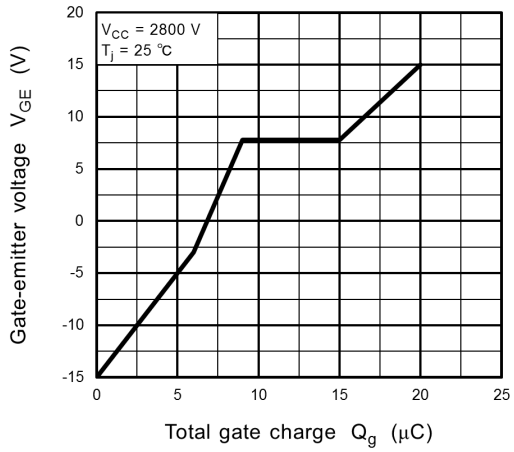


Fig. 7.5 V_{GE} - Q_g

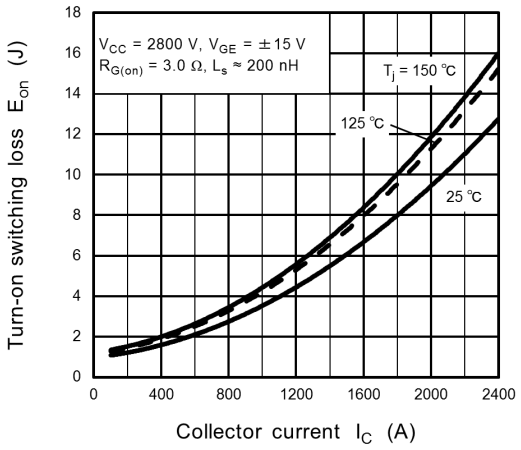


Fig. 7.6 E_{on} - I_C

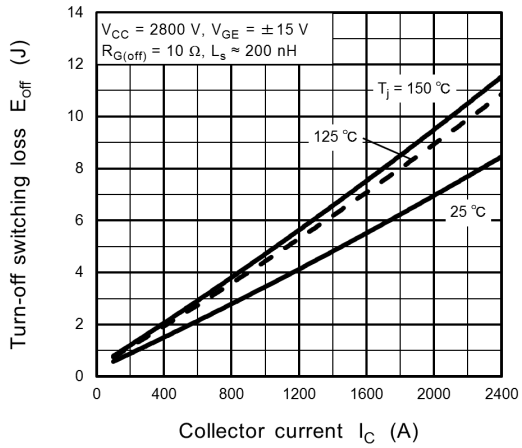


Fig. 7.7 E_{off} - I_C

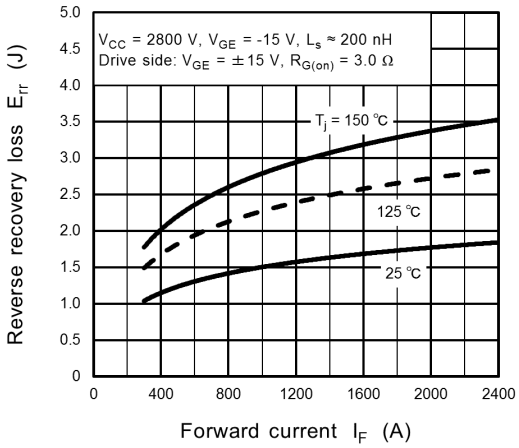


Fig. 7.8 E_{rr} - I_F

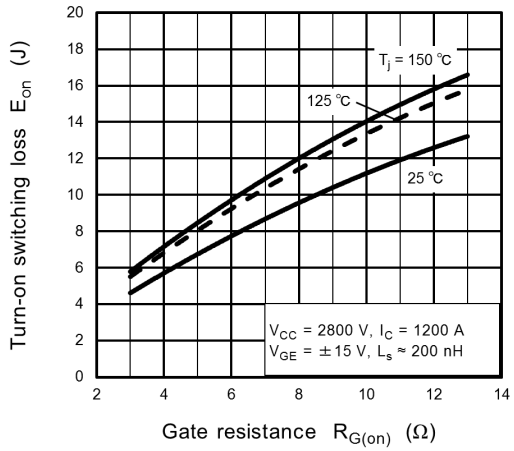


Fig. 7.9 E_{on} - $R_{G(on)}$

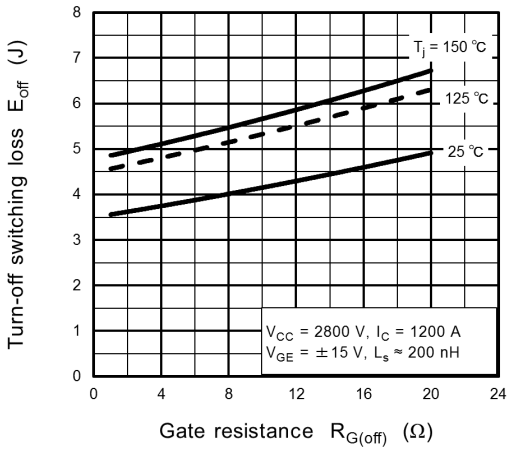


Fig. 7.10 E_{off} - $R_{G(off)}$

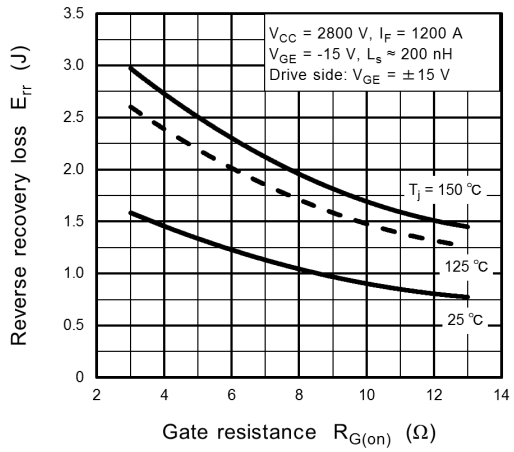


Fig. 7.11 E_{rr} - $R_{G(on)}$

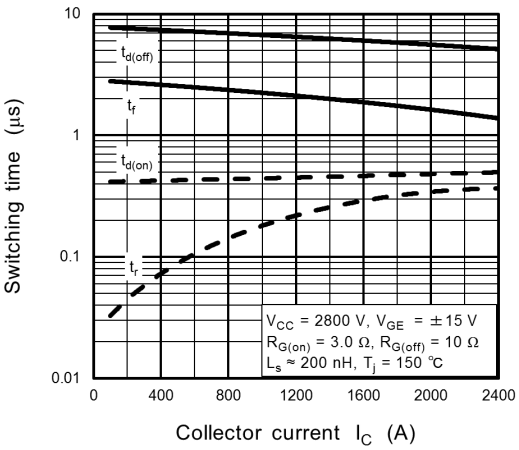


Fig. 7.12 $t_{d(off)}$,t_f,$t_{d(on)}$,t_r - I_C

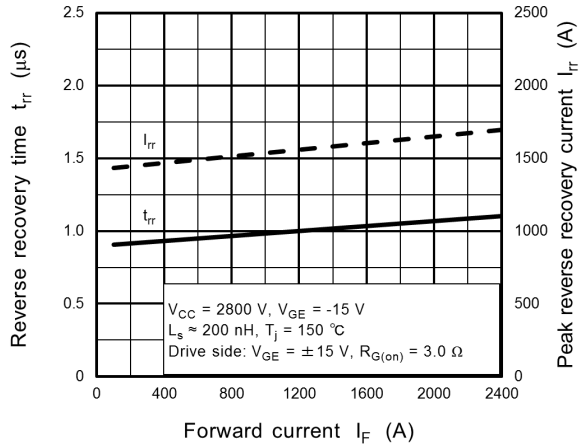


Fig. 7.13 t_{rr},I_{rr} - I_F

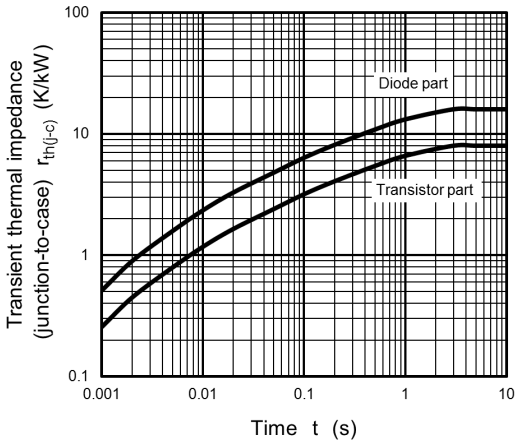


Fig. 7.14 $r_{th(j-c)}$ - t (Guaranteed Value)

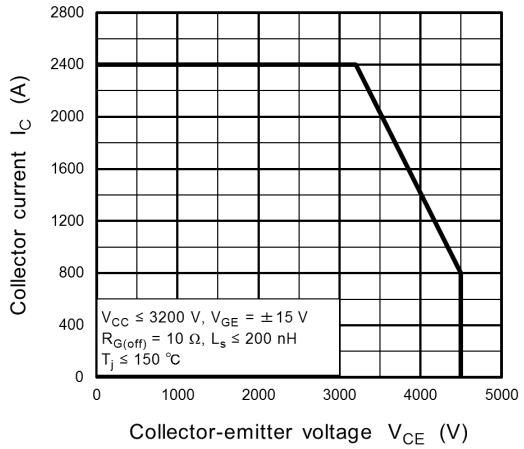


Fig. 7.15 RBSOA (Guaranteed Value)

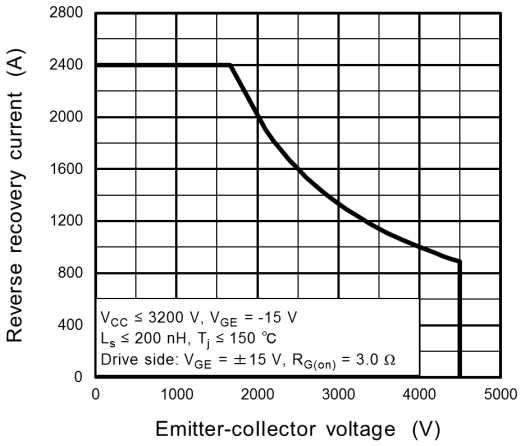
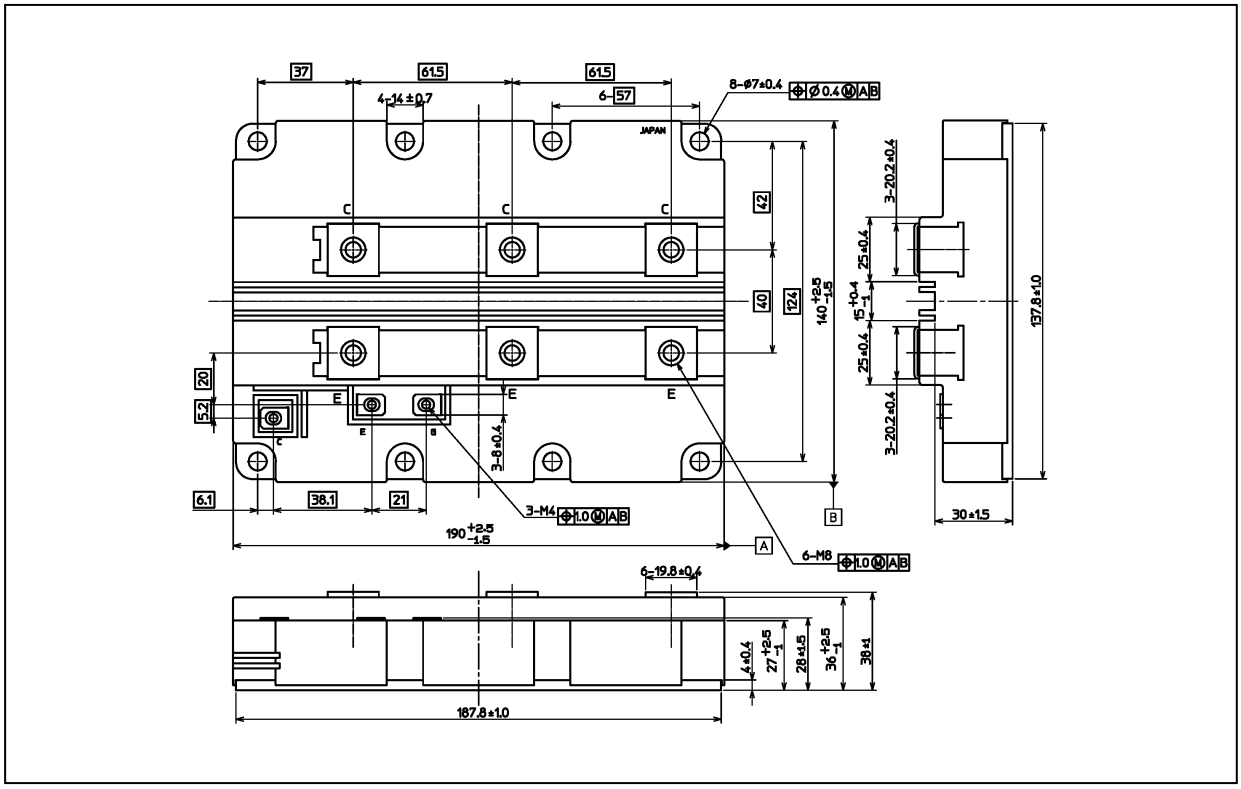


Fig. 7.16 RRSOA (Guaranteed Value)

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

Package Dimensions

Unit: mm



Weight: 1200 g (typ.)

Package Name(s)
TOSHIBA: 2-193D1A
Nickname: PMI193D

RESTRICTIONS ON PRODUCT USE

- Toshiba Corporation, and its subsidiaries and affiliates (collectively "TOSHIBA"), reserve the right to make changes to the information in this document, and related hardware, software and systems (collectively "Product") without notice.
- This document and any information herein may not be reproduced without prior written permission from TOSHIBA. Even with TOSHIBA's written permission, reproduction is permissible only if reproduction is without alteration/omission.
- Though TOSHIBA works continually to improve Product's quality and reliability, Product can malfunction or fail. Customers are responsible for complying with safety standards and for providing adequate designs and safeguards for their hardware, software and systems which minimize risk and avoid situations in which a malfunction or failure of Product could cause loss of human life, bodily injury or damage to property, including data loss or corruption. Before customers use the Product, create designs including the Product, or incorporate the Product into their own applications, customers must also refer to and comply with (a) the latest versions of all relevant TOSHIBA information, including without limitation, this document, the specifications, the data sheets and application notes for Product and the precautions and conditions set forth in the "TOSHIBA Semiconductor Reliability Handbook" and (b) the instructions for the application with which the Product will be used with or for. Customers are solely responsible for all aspects of their own product design or applications, including but not limited to (a) determining the appropriateness of the use of this Product in such design or applications; (b) evaluating and determining the applicability of any information contained in this document, or in charts, diagrams, programs, algorithms, sample application circuits, or any other referenced documents; and (c) validating all operating parameters for such designs and applications. **TOSHIBA ASSUMES NO LIABILITY FOR CUSTOMERS' PRODUCT DESIGN OR APPLICATIONS.**
- **PRODUCT IS NEITHER INTENDED NOR WARRANTED FOR USE IN EQUIPMENTS OR SYSTEMS THAT REQUIRE EXTRAORDINARILY HIGH LEVELS OF QUALITY AND/OR RELIABILITY, AND/OR A MALFUNCTION OR FAILURE OF WHICH MAY CAUSE LOSS OF HUMAN LIFE, BODILY INJURY, SERIOUS PROPERTY DAMAGE AND/OR SERIOUS PUBLIC IMPACT ("UNINTENDED USE").** Except for specific applications as expressly stated in this document, Unintended Use includes, without limitation, equipment used in nuclear facilities, equipment used in the aerospace industry, medical equipment, equipment used for automobiles, trains, ships and other transportation, traffic signaling equipment, equipment used to control combustions or explosions, safety devices, elevators and escalators, devices related to electric power, and equipment used in finance-related fields. **IF YOU USE PRODUCT FOR UNINTENDED USE, TOSHIBA ASSUMES NO LIABILITY FOR PRODUCT.** For details, please contact your TOSHIBA sales representative.
- Do not disassemble, analyze, reverse-engineer, alter, modify, translate or copy Product, whether in whole or in part.
- Product shall not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable laws or regulations.
- The information contained herein is presented only as guidance for Product use. No responsibility is assumed by TOSHIBA for any infringement of patents or any other intellectual property rights of third parties that may result from the use of Product. No license to any intellectual property right is granted by this document, whether express or implied, by estoppel or otherwise.
- **ABSENT A WRITTEN SIGNED AGREEMENT, EXCEPT AS PROVIDED IN THE RELEVANT TERMS AND CONDITIONS OF SALE FOR PRODUCT, AND TO THE MAXIMUM EXTENT ALLOWABLE BY LAW, TOSHIBA (1) ASSUMES NO LIABILITY WHATSOEVER, INCLUDING WITHOUT LIMITATION, INDIRECT, CONSEQUENTIAL, SPECIAL, OR INCIDENTAL DAMAGES OR LOSS, INCLUDING WITHOUT LIMITATION, LOSS OF PROFITS, LOSS OF OPPORTUNITIES, BUSINESS INTERRUPTION AND LOSS OF DATA, AND (2) DISCLAIMS ANY AND ALL EXPRESS OR IMPLIED WARRANTIES AND CONDITIONS RELATED TO SALE, USE OF PRODUCT, OR INFORMATION, INCLUDING WARRANTIES OR CONDITIONS OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, ACCURACY OF INFORMATION, OR NONINFRINGEMENT.**
- Do not use or otherwise make available Product or related software or technology for any military purposes, including without limitation, for the design, development, use, stockpiling or manufacturing of nuclear, chemical, or biological weapons or missile technology products (mass destruction weapons). Product and related software and technology may be controlled under the applicable export laws and regulations including, without limitation, the Japanese Foreign Exchange and Foreign Trade Law and the U.S. Export Administration Regulations. Export and re-export of Product or related software or technology are strictly prohibited except in compliance with all applicable export laws and regulations.
- Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. Please use Product in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive. **TOSHIBA ASSUMES NO LIABILITY FOR DAMAGES OR LOSSES OCCURRING AS A RESULT OF NONCOMPLIANCE WITH APPLICABLE LAWS AND REGULATIONS.**